## FAST RECOVERY, HIGH POWER, MICRO HIGH VOLTAGE RECTIFIERS

## DESCRIPTION

The MC5610 through MC5619 series of fast recovery high voltage silicon rectifiers feature the smallest packages available. They are ideal for high-reliability where a failure cannot be tolerated. These 0.275 to 0.790 amp rated rectifiers for working peak reverse voltages from 1500 to 5000 volts are hermetically sealed with void-less glass construction. Typical applications include transmitters, power supplies, radar equipment and X-ray machines. Surface mount MELF package configurations are also available by adding "US" suffix. Microsemi also offers numerous other rectifier products to meet higher and lower current ratings with various recovery time speed requirements including fast and ultrafast device types in both through-hole and surface mount packages.

Important: For the latest information, visit our website http://www.microsemi.com.

## FEATURES

- Void-less hermetically sealed glass package.
- Triple-layer passivation.
- Lowest reverse leakage available.
- Absolute high voltage / high temperature stability.
- RoHS compliant versions available.


## APPLICATIONS / BENEFITS

- High voltage standard recovery rectifiers 1500 to 5,000 volts.
- Military and other high-reliability applications.
- Applications include bridges, half-bridges, catch diodes, voltage multipliers, X-ray machines, power supplies, transmitters, and radar equipment.
- High forward surge current capability.
- Extremely robust construction.
- Inherently radiation hard as described in Microsemi MicroNote 050.

MAXIMUM RATINGS @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Parameters/Test Conditions | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Junction Temperature MC5610 - MC5612 <br>  MC5613 - MC5616 <br>  MC5617 - MC5619 | TJ | $\begin{aligned} & \hline-55 \text { to }+150 \\ & -65 \text { to }+150 \\ & -65 \text { to }+125 \\ & \hline \end{aligned}$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | TSTG | -65 to +175 | ${ }^{\circ} \mathrm{C}$ |
| Thermal Resistance Junction-to-Lead @ 3/8 inch ( 10 mm ) lead length from body | $\mathrm{R}_{\text {өЈı }}$ | 38 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Working Peak Reverse Voltage: MC5610 \& MC5613 <br>  MC5611 \& MC5614 <br>  MC5612 \& MC5615 <br>  MC5616 <br>  MC5617 <br>  MC5618 <br>  MC5619 | $\mathrm{V}_{\text {RWM }}$ | $\begin{aligned} & 1500 \\ & 2000 \\ & 2500 \\ & 3000 \\ & 4000 \\ & 4500 \\ & 5000 \end{aligned}$ | V |
| Solder Temperature @ 10 s | $\mathrm{T}_{\text {SP }}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

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## MECHANICAL and PACKAGING

- CASE: Hermetically sealed void-less hard glass with tungsten slugs.
- TERMINALS: Tin/lead (Sn/Pb) or RoHS compliant matte/tin over copper.
- MARKING: Alphanumeric.
- POLARITY: Cathode indicated by band.
- TAPE \& REEL option: Standard per EIA-296. Consult factory for quantities.
- WEIGHT: 400 milligrams (approx).
- See Package Dimensions on last page.


## PART NOMENCLATURE



| SYMBOLS \& DEFINITIONS |  |
| :---: | :--- |
| Symbol | Definition |
| $I_{0}$ | Average Rectified Forward Current: The output current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave <br> input and a 180 degree conduction angle. |
| $\mathrm{I}_{\mathrm{R}}$ | Maximum Leakage Current: The maximum leakage current that will flow at the specified voltage and temperature. |
| $\mathrm{I}_{\mathrm{ZSM}}$ | Maximum Rated Surge Current: The non-repetitive peak value of rated surge current at a specified wave form. |
| $\mathrm{V}_{(\mathrm{BR})}$ | Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current. |
| $\mathrm{V}_{\mathrm{F}}$ | Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current. |
| $\mathrm{V}_{\mathrm{R}}$ | Reverse Voltage: The reverse voltage dc value, no alternating component. |
| $\mathrm{V}_{\mathrm{RWM}}$ | Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature <br> range. |

## ELECTRICAL CHARACTERISTICS

| MICROSEMI PART NUMBER | $\begin{gathered} \text { RMS } \\ \text { volTAGE } \\ \mathrm{V}_{\mathrm{R}(\mathrm{RMS})} \end{gathered}$ | AVERAGE RECTIFIED CURRENT $\mathrm{I}_{\mathrm{O}}$ @ $\mathrm{T}_{\mathrm{L}}=$ (Note 2) |  | MAXIMUM FORWARD VOLTAGE $\mathrm{V}_{\mathrm{F}}$ @ 100 mA | MAXIMUM REVERSE CURRENT $\mathrm{I}_{\mathrm{R}} @ \mathrm{~V}_{\mathrm{Rwm}}$ <br> $25^{\circ} \mathrm{C}$ | MAXIMUM REVERSE CURRENT $\mathrm{I}_{\mathrm{R}} @ \mathrm{~V}_{\mathrm{Rwm}}$$100^{\circ} \mathrm{C}$ | MAXIMUM FORWARD SURGE Ifs @ 8.3 ms | MAXIMUM REVERSE RECOVERY TIME $t_{r r}$ (Note 1) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $55^{\circ} \mathrm{C}$ | $100{ }^{\circ} \mathrm{C}$ |  |  |  |  |  |
|  | Volts | mA | mA | Volts | $\mu \mathrm{A}$ | $\mu \mathrm{A}$ | Amps | ns |
| MC5610 | 1050 | 790 | 415 | 3.0 | 1.0 | 25 | 8 | 300 |
| MC5611 | 1400 | 630 | 330 | 4.0 | 1.0 | 25 | 6 | 300 |
| MC5612 | 1750 | 530 | 280 | 5.0 | 1.0 | 25 | 5 | 300 |
| MC5613 | 1050 | 975 | 515 | 3.0 | 1.0 | 20 | 8 | 300 |
| MC5614 | 1400 | 790 | 415 | 4.0 | 1.0 | 20 | 6 | 300 |
| MC5615 | 1750 | 665 | 350 | 5.0 | 1.0 | 20 | 5 | 300 |
| MC5616 | 2100 | 570 | 300 | 6.0 | 1.0 | 20 | 4 | 300 |
| MC5617 | 2800 | 330 | 120 | 8.0 | 2.5 | 50 | 3 | 300 |
| MC5618 | 3150 | 300 | 110 | 9.0 | 2.5 | 50 | 2.7 | 300 |
| MC5619 | 3500 | 275 | 100 | 10.0 | 2.5 | 50 | 2.5 | 300 |

NOTE 1: $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}, \mathrm{I}_{\mathrm{RM}}=100 \mathrm{~mA}, \mathrm{I}_{\mathrm{R}(\mathrm{REC})}=25 \mathrm{~mA}$.
NOTE 2: Heat sink $3 / 8$ " from body.

## GRAPHS



FIGURE 1
Average Rectified Current vs. Lead Temperature
Lead Temperature ( ${ }^{\circ}$ C) ( $\mathrm{L}=3 / 8$ inch)

## PACKAGE DIMENSIONS



## NOTES:

1. Dimensions are in inches.
2. Millimeters are given for general information only.
3. Package contour optional with BD and length BL. Heat slugs, if any, shall be included within this cylinder length but shall not be subject to minimum limit of BD.
4. The specified lead diameters apply in the zone between .050 inch $(1.27 \mathrm{~mm})$ from the diode body and the end of the lead.
5. In accordance with ASME Y14.5M, diameters are equivalent to $\Phi x$ symbology.

| Ltr | DIMENSIONS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | INCH |  | MILLIMETERS |  |  |
|  | Min | Max | Min | Max |  |
| BD | .065 | .110 | 1.65 | 2.79 | 3 |
| BL | .190 | .215 | 4.83 | 5.46 | 3 |
| LD | .029 | .033 | 0.74 | 0.84 |  |
| LL | 1.00 | 1.25 | 25.40 | 31.75 |  |
| LU |  | .050 |  | 1.27 | 4 |

